



NTE5417 thru NTE5419 Silicon Controlled Rectifier (SCR) 10 Amp

Absolute Maximum Ratings:

Repetitive Peak Reverse Voltage ($T_C = +110^\circ\text{C}$), V_{RRM}

NTE5417	200V
NTE5418	400V
NTE5419	600V

Repetitive Peak Off-State Voltage ($T_C = +110^\circ\text{C}$), V_{DRM}

NTE5417	200V
NTE5418	400V
NTE5419	600V

RMS On-State Current ($T_C = +80^\circ\text{C}$, Conduction Angle of 180°), $I_{\text{T(RMS)}}$ 10A

Peak Surge (Non-Repetitive) On-State Current (One Cycle at 50 or 60Hz), I_{TSM} 100A

Peak Gate-Trigger Current (3μs Max), I_{GTM} 1A

Peak Gate-Power Dissipation ($I_{\text{GT}} \leq I_{\text{GTM}}$), P_{GM} 16W

Average Gate Power Dissipation, $P_{\text{G(AV)}}$ 500mW

Operating Temperature Range, T_{opr} -40° to $+110^\circ\text{C}$

Storage Temperature Range, T_{stg} -40° to $+150^\circ\text{C}$

Typical Thermal Resistance, Junction-to-Case, R_{thJC} 2.5°C/W

Electrical Characteristics: ($T_C = +25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Peak Off-State Current	I_{RRM}	$V_{\text{RRM}} = \text{Max}$, $V_{\text{DRM}} = \text{Max}$, $T_C = +110^\circ\text{C}$	—	—	0.5	mA
	I_{DRM}		—	—	0.5	mA
Maximum Peak On-State Voltage	V_{TM}	$I_{\text{T}} = 10\text{A}$	—	—	1.8	V
DC Holding Current	I_{HOLD}	Gate Open	—	—	30	mA
DC Gate-Trigger Current	I_{GT}	$V_D = 6\text{VDC}$, $R_L = 60\Omega$	—	—	25	mA
DC Gate-Trigger Voltage	V_{GT}	$V_D = 6\text{VDC}$, $R_L = 60\Omega$	—	—	1.5	V
Gate Controlled Turn-On Time	t_{gt}	$I_{\text{GT}} = 100\text{mA}$	—	2.5	—	μs
Critical Rate of Off-State Voltage	dv/dt (critical)	Gate Open, $T_C = +100^\circ\text{C}$	—	200	—	V/μs

